



**Small Surface Mount Ultra Fast Recovery Rectifiers**  
**Reverse Voltage 100 to 800 Volts, Forward Current 1.0 Ampere**

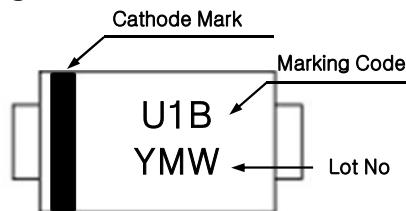
**Features**

- For surface mounted applications
- Low profile package
- Ideal for automated placement
- Glass passivated chip junction
- High temperature soldering : 260°C / 10 seconds at terminals
- Lead free in comply with EU RoHS 2002/95/EC directives.
- Green molding compound as per IEC61249 Std..(Halogen Free)

**Mechanical Data**

- Case : JEDEC SOD-123FL, Molded plastic
- Terminals : Solderable per MIL-STD-750, Method 2026
- Polarity : Color band denotes cathode end
- Weight : 0.015 gram (Approx.)

**Marking**

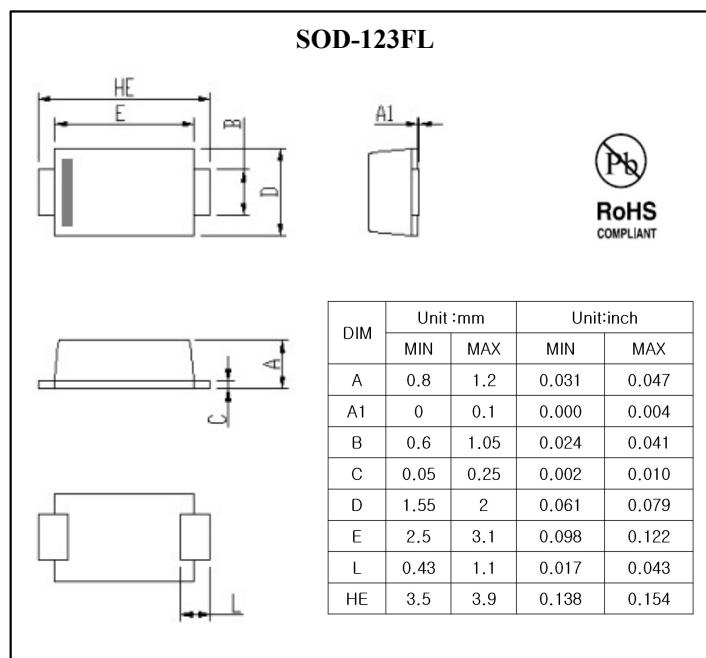


**Maximum Ratings & Electrical Characteristics**

Ratings at 25°C ambient temperature unless otherwise specified

Single phase half wave 60 HZ, resistive or inductive load

For capacitive load, derate current by 20%



Parameter	Symbol	US 1001FL	US 1002FL	US 1004FL	US 1006FL	US 1008FL	Unit	Remark		
Marking Code		U1B	U1D	U1G	U1J	U1K				
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	100	200	400	600	800	V			
Maximum RMS Voltage	V <sub>RMS</sub>	70	140	280	420	560	V			
Maximum DC Blocking Voltage	V <sub>DC</sub>	100	200	400	600	800	V			
Maximum Average Forward Rectified Current	I <sub>F(AV)</sub>	1.0					A			
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC Method)	I <sub>FSM</sub>	30					A			
Maximum Instantaneous Forward Voltage	V <sub>F</sub>	1.0		1.4	1.7		V	I <sub>F</sub> =1A		
Maximum DC Reverse Current at Rated DC Blocking Voltage	I <sub>R</sub>	10					uA	Ta=25°C		
		50					uA	Ta=125°C		
Typical Junction Capacitance	C <sub>J</sub>	9.0					pF	Note 1		
Reverse Recovery Time	trr	50		100		ns	Note 2			
Typical Thermal Resistance	R <sub>th(j-a)</sub>	180					°C /W	Note 3		
Operation Junction Temperature Range	T <sub>J</sub>	-55 to +150					°C			
Storage Temperature Range	T <sub>STG</sub>	-55 to +150					°C			

Note 1. Measured at 1MHz and Applied Reverse Voltage of 4.0Volts D.C.

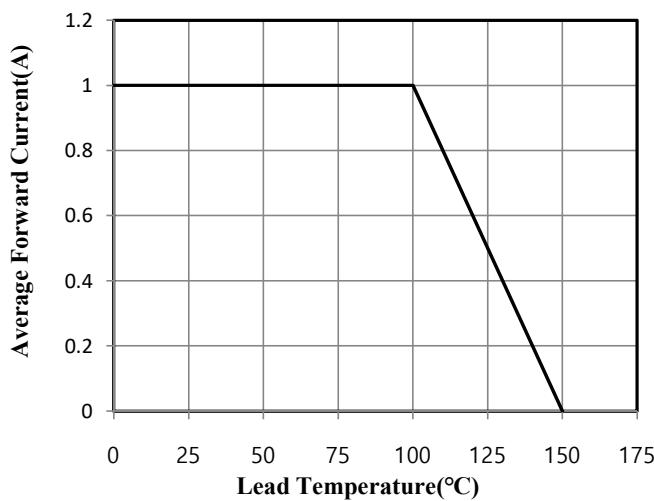
Note 2. Reverse Recovery Test Conditions : I<sub>F</sub>=0.5A, I<sub>R</sub>=1.0A, I<sub>RR</sub>=0.25A

Note 3. Thermal resistance from junction to ambient.

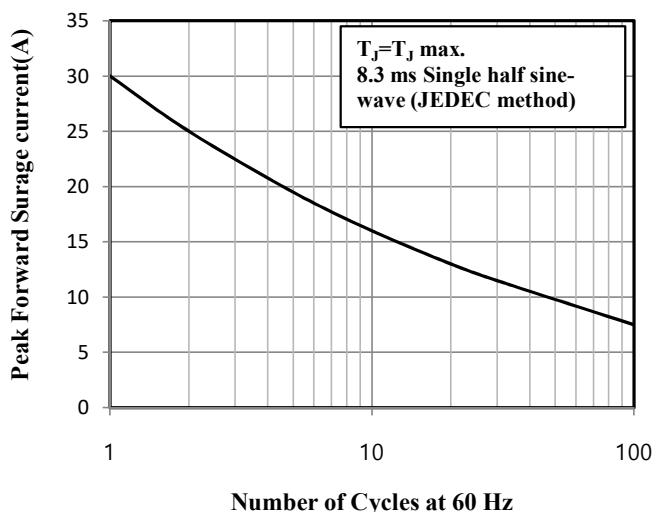


Ratings and Characteristics Curves ( $T_a=25^\circ\text{C}$  unless otherwise noted)

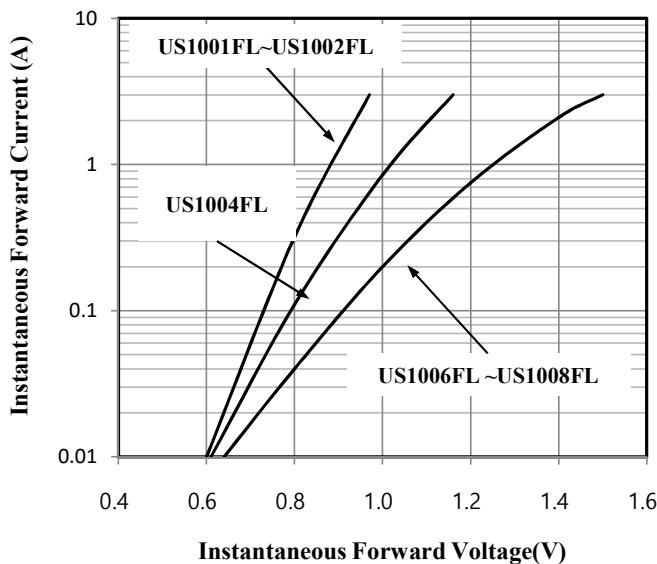
**Fig.1 Forward Current Derating Curve**



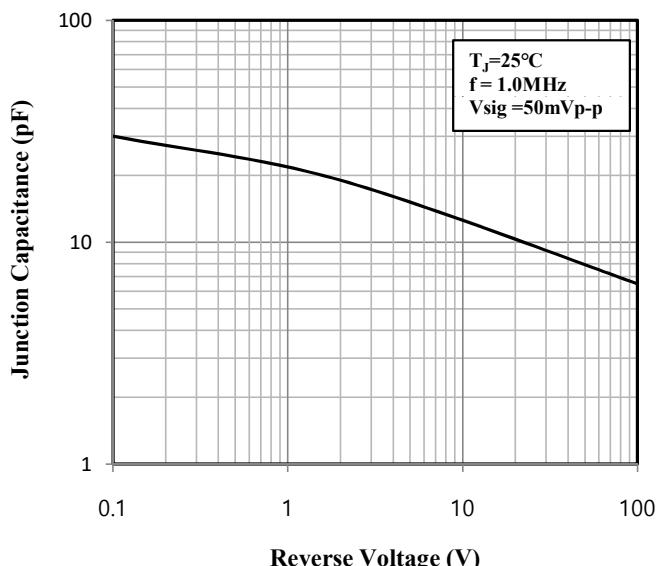
**Fig.2 Maximum Non-Repetitive Peak Forward Surge Current**



**Fig.3 Typical Instantaneous Forward Characteristics**



**Fig.4 Typical Junction Capacitance**



**Fig.5 Typical Reverse Characteristics**

